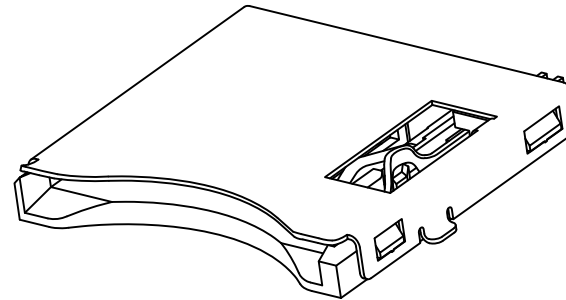
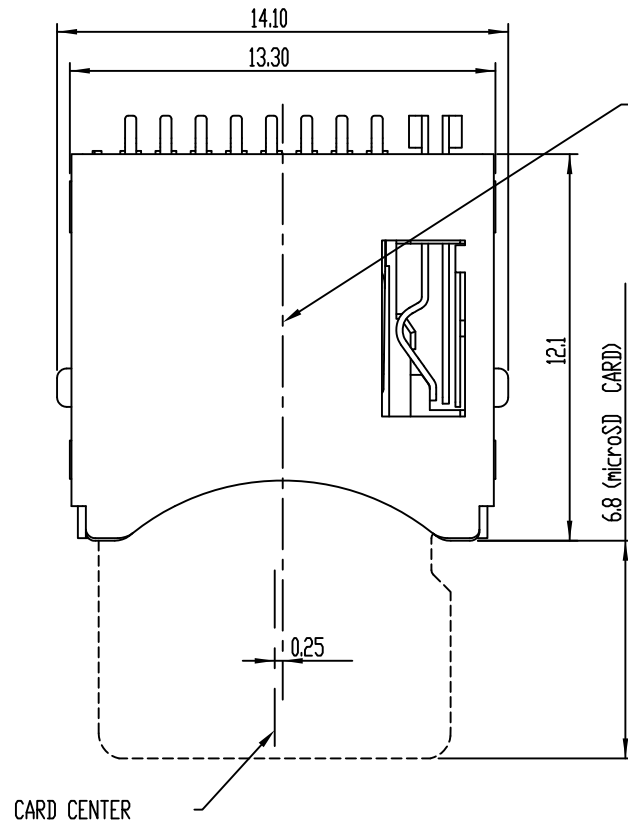


MATERIAL:  
 INSULATOR: HIGH TEMPRATURE THERMOPLASTIC,  
 UL94V-0,BLACK  
 CONTACT: PHOSPHOR BRONZE  
 PLATING:  
 CONTACT AREA PLATING: GOLD FLASH and 10u" OVER Ni  
 SOLDER AREA : Tin Plated OVER 50u" Ni



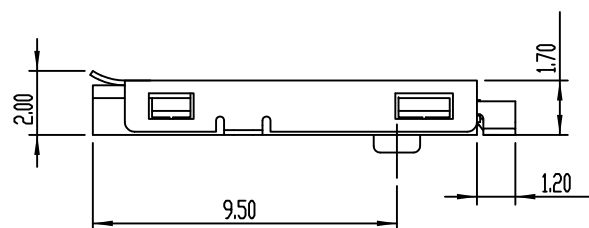
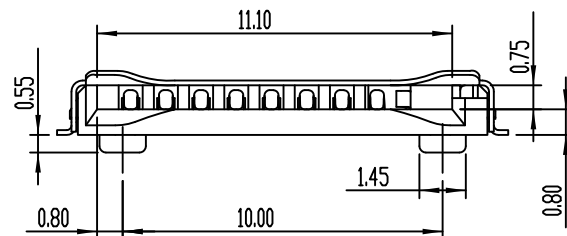
112I-T X A 0-R  
 1 2 3 4


1.Type  
 T:TOP Mount

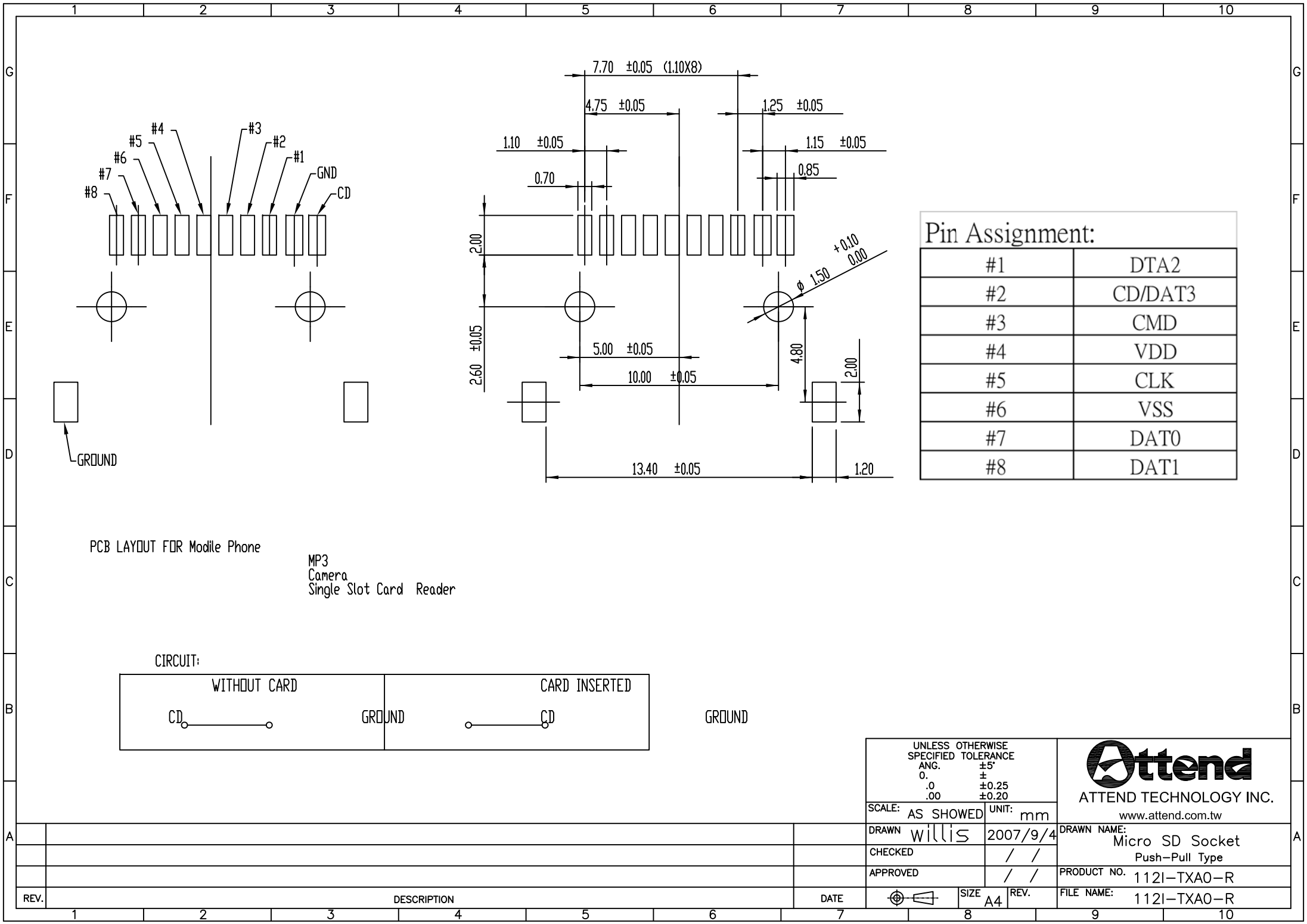
2.Contact Plating  
 A:Gold Flash  
 D:10u"Gold Plating

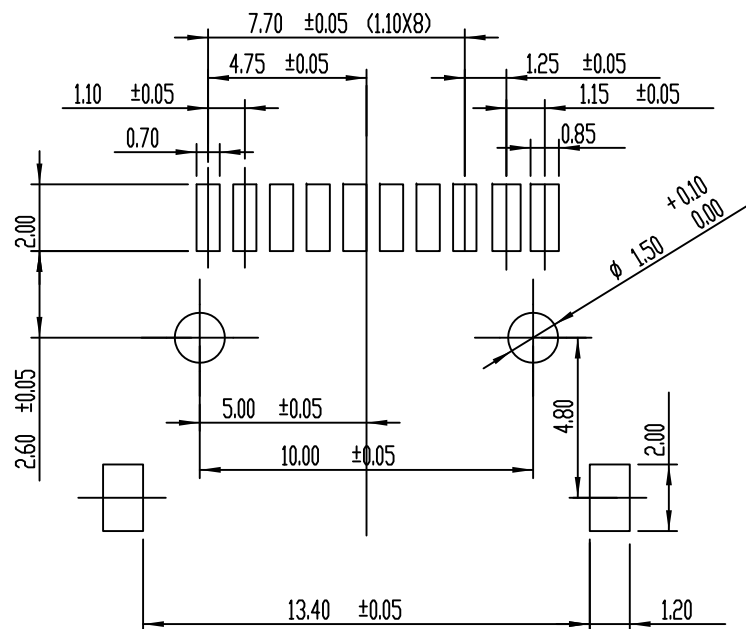
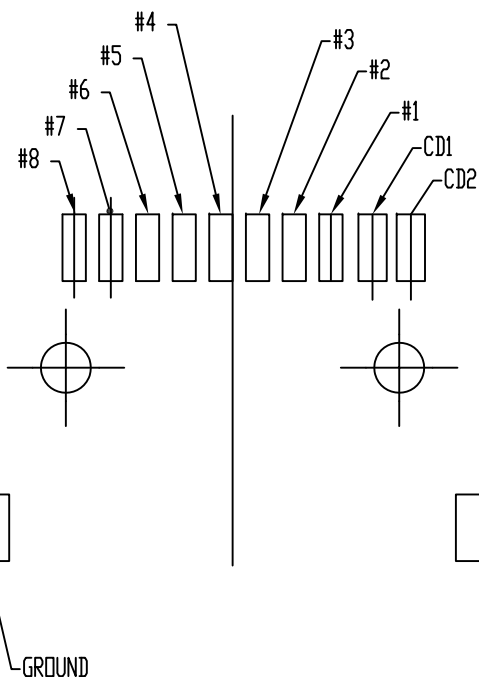
3.Stand Off  
 A:0mm

4.RoHS



UNLESS OTHERWISE SPECIFIED TOLERANCE		 <b>ATTEND TECHNOLOGY INC.</b> <a href="http://www.attend.com.tw">www.attend.com.tw</a>	
ANG.	±5°		
0.	±	SCALE: AS SHOWN UNIT: mm DRAWN <b>willis</b> 2007/9/4 CHECKED / / APPROVED / /	
.0	±0.25		
.00	±0.20	DRAWN NAME: Micro SD Socket Push-Pull Type PRODUCT NO. 112I-TXA0-R FILE NAME: 112I-TXA0-R	
REV.	DESCRIPTION	DATE	SIZE A4 REV.



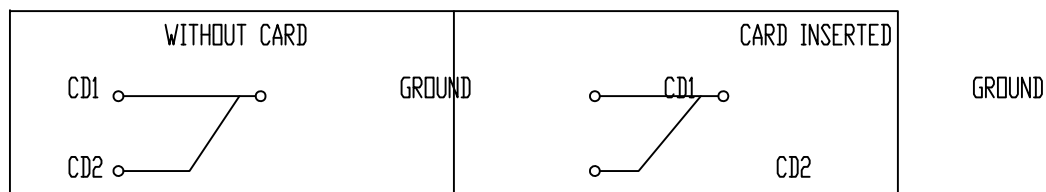


### Pin Assignment:

#1	DTA2
#2	CD/DAT3
#3	CMD
#4	VDD
#5	CLK
#6	VSS
#7	DAT0
#8	DAT1

### PCB LAYOUT FOR Multi Slot Card Reader

#### CIRCUIT:



UNLESS OTHERWISE SPECIFIED TOLERANCE	
ANG.	$\pm 5^\circ$
0.	$\pm$
.0	$\pm 0.25$
.00	$\pm 0.20$
SCALE:	AS SHOWN
UNIT:	mm
DRAWN	willis
CHECKED	/ /
APPROVED	/ /
DATE	
SIZE	A4



ATTEND TECHNOLOGY INC.

www.attend.com.tw

DRAWN NAME: Micro SD Socket  
Push-Pull Type

PRODUCT NO. 112I-TXA0-R

FILE NAME: 112I-TXA0-R

REV.	DESCRIPTION	DATE	SIZE	REV.
1			A4	